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Hajime SOGA	February 8, 2001		
Kenji KONDO	Execution date February 8, 2001		
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Eiji ISHIKAWA	February 8, 2001		
Yoshikazu SAKANO	February 8, 2001		
Mikimasa SUSUKI	February 8, 2001		
	0		
Descriving Posts	if additional names of receiving parties attached		
Receiving Party ()Mark	If additional names of receiving parties attached		
DENSO CORPORATION			
1-1, Showa-cho			
Kariya-city, Aichi-pref.			
448-8661 JAPAN			
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> **PATENT REEL: 011562 FRAME: 0557**

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ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby expressly acknowledged, the undersigned hereby agree(s) to assign, and hereby sell(s), assign(s) and transfer(s) to

DENSO CORPORATION; 1-1, Showa-cho, Kariya-city, Aichi-pref., 448-8661, Japan

as Assignee, and its successors, assigns and legal representatives, the entire right, title and interest, in the United States of America and all foreign countries, to certain inventions known as

METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE AND INSULATED GATE TYPE POWER TRANSISTOR described in an application for Letters Patent of the United States executed (A) X On even date herewith (C) As U.S. Application Serial No. Filed on as well as any and all continuations, divisions, and substitutes and reissues of said application for Letters Patent, and all Letters Patent that may be granted therefor. The undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to said Assignee. The undersigned agree(s), when requested, to sign all papers, take all rightful oaths, and perform all acts which may be necessary for securing and maintaining patents for said inventions and for vesting title thereto in said Assignee. The undersigned authorize(s) and empower(s) said Assignee to invoke and claim the benefit of the right of priority provided by the International Convention for the Protection of Industrial Property, or by any convention which may be henceforth substituted therefor, as may be necessary in connection with said application for said Letters Patent. The undersigned also authorize(s) Law Office of David G. Posz to insert hereon any further identification that may be necessary or desirable for recordation of this document. Hidetoshi Muramoto Witness Hajime Soga
Inventor 1: Hajime SOGA February 8, 2001 Kenji Kondo February 8. 200/ February 8.200/ Hidetoshi Muramoto

Witness

February 8.200/ Hidetoshi Muramoto

Witness

Witness Eigi Ish Lawa
Inventor 3: Elji ISHIKAWA Yoshikazu Sakano Inventor 4: Yoshikazu SAKANO Hidetoshi Muramoto Mikimasa Juguki
Inventor 5: Mikimasa SUZUKI Tebruary 8. >00/ Witness

Continued on page 2 for additional inventors

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